onsemi

XGS 30000

CMOS Image Sensor, 29.8 Mp, Global Shutter

Product Overview

For complete documentation, see the data sheet.

The device provides high resolution, global shutter imaging with high readout speed and a low power footprint for industrial imaging customers. Two speed grades are available to match device output to key computer interfaces and application requirements. The XGS 30000 shares a common design and footprint with other members of the XGS family, such as the XGS 20000 or XGS 45000, allowing one camera design to support multiple resolutions to simplify and speed time to market for new camera designs. The XGS 30000 is available in a 251-pin µPGA package in both monochrome and Bayer color configurations.

Features

- Advanced 3.2 µm global shutter pixel
- Energy efficient design
- Available speed grades
- 1:1 (square) aspect ratio

Applications

• Image capture

Benefits

- High resolution with high image quality and uniformity
- Reduced power and thermal footprints
- Match to key computer interfaces and application requirements
- Maximize image capture within lens optical circle

End Products

- Industrial cameras and systems
- Inspection system (food, bottles, recycling labels, etc.)
- Security cameras and systems
- Machine Vision camera
- Broadcasting

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Product	Pricing (\$/Unit)	Complian ce	Status	Туре	Megapi xels	Frame Rate (fps)	Optical Format	Shutter Type	Pixel Size (µm)	Output Interfac e	Color	Packag e Type
NOIX0SE030KB -GTI		Pb H	Active	CMOS	29.8	48	APS-C	Global Shutter	3.2 x 3.2	HiSPi™	Bayer Color	CPGA2 51 44.40x 37.25
NOIXOSN030KB -GTI		PD H	Active	CMOS	29.8	48	APS-C	Global Shutter	3.2 x 3.2	HiSPi™	Mono	CPGA2 51 44.40x 37.25
NOIX1SE030KB- GTI		6 H	Active	CMOS	29.8	31	APS-C	Global Shutter	3.2 x 3.2	HiSPi™	Bayer Color	CPGA2 51 44.40x 37.25
NOIX1SN030KB -GTI		PD H	Active	CMOS	29.8	31	APS-C	Global Shutter	3.2 x 3.2	HiSPi™	Mono	CPGA2 51 44.40x 37.25

Part Electrical Specifications